

# BC846BS 65 V, 100 mA NPN/NPN general-purpose transistor Rev. 01 — 24 August 2009 Produ

Product data sheet

# 1. Product profile

## 1.1 General description

NPN/NPN general-purpose transistor pair in a very small Surface-Mounted Device (SMD) plastic package.

#### Table 1. **Product overview**

Type number			PNP/PNP	NPN/PNP	
	NXP	JEITA	complement	complement	
BC846BS	SOT363	SC-88	BC856BS	BC846BPN	

## 1.2 Features

- Low collector capacitance
- Low collector-emitter saturation voltage
- Closely matched current gain
- Reduces number of components and board space
- No mutual interference between the transistors
- AEC-Q101 qualified

## **1.3 Applications**

General-purpose switching and amplification

## 1.4 Quick reference data

Table 2.	Quick reference data					
Symbol	Parameter	Min	Тур	Max	Unit	
Per trans	istor					
$V_{CEO}$	collector-emitter voltage	open base	-	-	65	V
I <sub>C</sub>	collector current		-	-	100	mA
h <sub>FE</sub>	DC current gain	$V_{CE}$ = 5 V; $I_C$ = 2 mA	200	300	450	



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#### **Pinning information** 2.

Table 3.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	emitter TR1		
2	base TR1		
3	collector TR2		
4	emitter TR2		
5	base TR2		
6	collector TR1		1 2 3
			sym020

#### **Ordering information** 3.

Table 4.         Ordering information					
Type number	Package				
	Name	Description	Version		
BC846BS	SC-88	plastic surface-mounted package; 6 leads	SOT363		

#### 4. Marking

Table 5. Marking codes	
Type number	Marking code <sup>[1]</sup>
BC846BS	*E5
<ul> <li>* = -: made in Hong Kong</li> <li>* = p: made in Hong Kong</li> </ul>	

- \* = t: made in Malaysia
- \* = W: made in China

#### Limiting values 5.

#### Table 6. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per transis	stor				
V <sub>CBO</sub>	collector-base voltage	open emitter	-	80	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	65	V
$V_{\text{EBO}}$	emitter-base voltage	open collector	-	6	V
I <sub>C</sub>	collector current		-	100	mA
I <sub>CM</sub>	peak collector current	single pulse; $t_p \leq 1 ms$	-	200	mA
I <sub>BM</sub>	peak base current	single pulse; $t_p \leq 1 ms$	-	200	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> -	200	mW

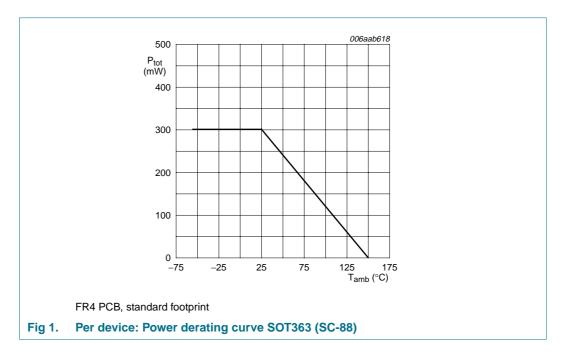
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 Table 6.
 Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per device					
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	300	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



## 6. Thermal characteristics

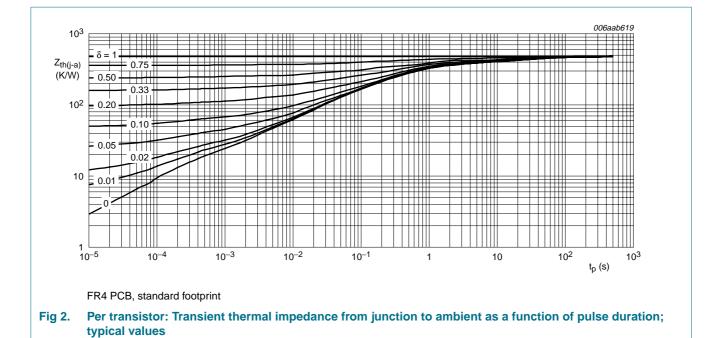
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transi	stor					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	-	625	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		-	-	230	K/W
Per device	9					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	-	416	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

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## 7. Characteristics

## Table 8.Characteristics

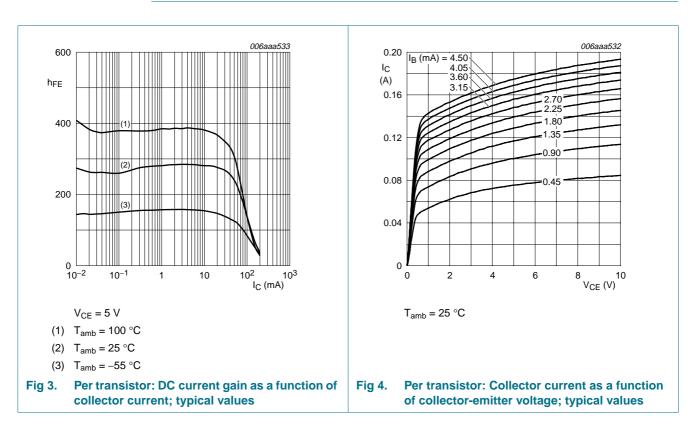
 $T_{amb} = 25 \circ C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
Per trans	Per transistor						
I <sub>CBO</sub>	collector-base cut-off	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$	-	-	15	nA	
	current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$	-	-	5	μA	
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 6 V; I_C = 0 A$	-	-	100	nA	
h <sub>FE</sub>	DC current gain	$V_{CE} = 5 V$					
		I <sub>C</sub> = 10 μA	-	280	-		
		I <sub>C</sub> = 2 mA	200	300	450		
V <sub>CEsat</sub>	collector-emitter	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$	-	55	100	mV	
	saturation voltage	$I_{C} = 100 \text{ mA}; I_{B} = 5 \text{ mA}$	-	200	300	mV	
V <sub>BEsat</sub>	base-emitter	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$	-	755	850	mV	
	saturation voltage	$I_{C} = 100 \text{ mA}; I_{B} = 5 \text{ mA}$	-	1000	-	mV	
$V_{BE}$	base-emitter voltage	$V_{CE} = 5 V$					
		$I_{\rm C} = 2  \rm mA$	580	650	700	mV	
		I <sub>C</sub> = 10 mA	-	-	770	mV	

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$I_{amb} = 20$	T <sub>amb</sub> = 25 °C unless otherwise specified.					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A};$ f = 1 MHz	-	1.9	-	pF
C <sub>e</sub>	emitter capacitance	$\label{eq:Veb} \begin{split} V_{EB} &= 0.5 \text{ V};  \text{I}_{C} = \text{i}_{c} = 0 \text{ A}; \\ \text{f} &= 1 \text{ MHz} \end{split}$	-	11	-	pF
f <sub>T</sub>	transition frequency	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 10 \text{ mA};$ f = 100 MHz	100	-	-	MHz
NF noise figure	noise figure		-	1.9	-	dB
			-	3.1	-	dB

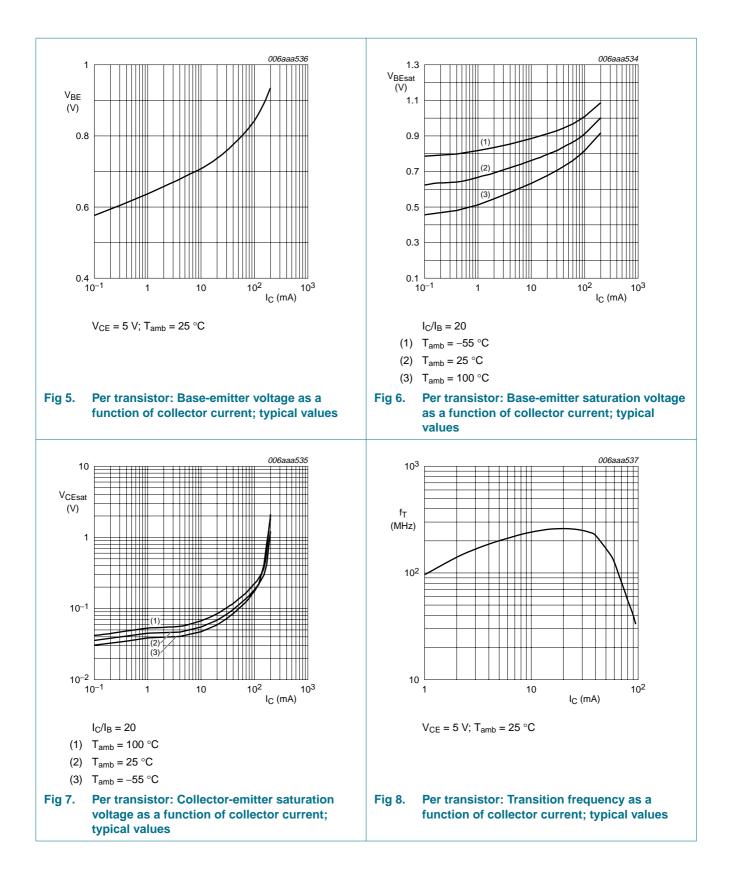
# Table 8.Characteristics ... continued $T_{omb} = 25 \,^{\circ}C$ unless otherwise specified



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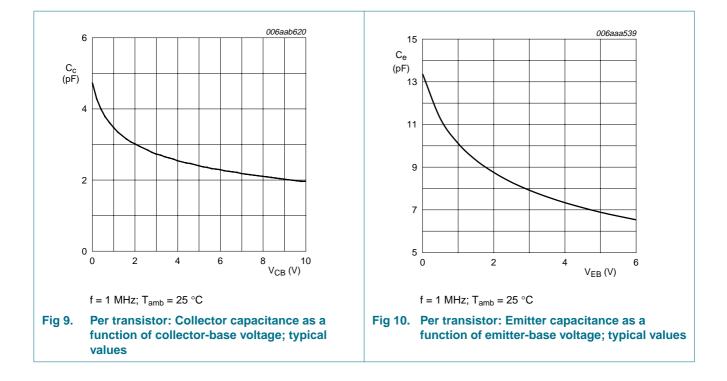
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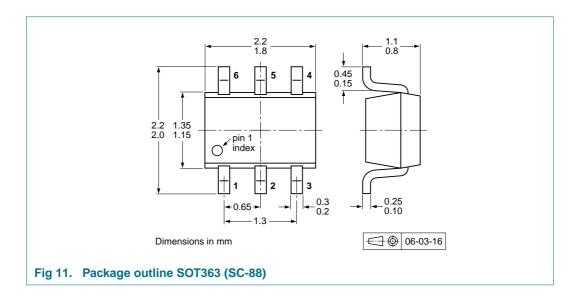
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## 8. Test information

## 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

## 9. Package outline



## **10. Packing information**

### Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	e number Package Description		Packing quantity		
				3000	10000
BC846BS	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-135
		4 mm pitch, 8 mm tape and reel; T2	[3]	-125	-165

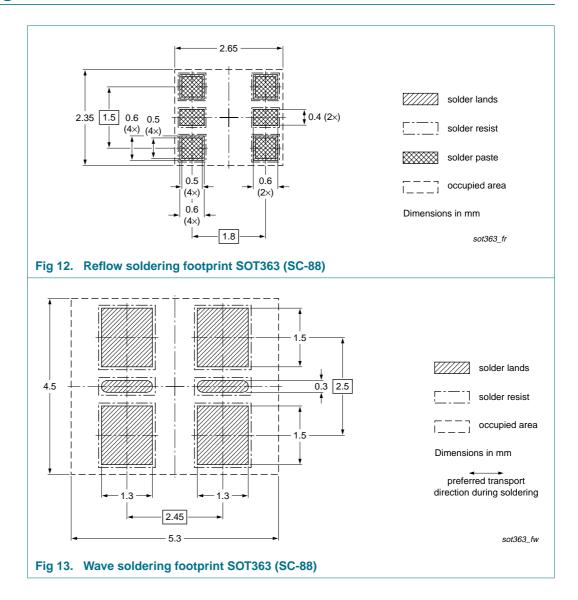
[1] For further information and the availability of packing methods, see <u>Section 14</u>.

[2] T1: normal taping

[3] T2: reverse taping

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# **11. Soldering**



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# **12. Revision history**

Table 10. Revision history							
Document ID	Release date	Data sheet status	Change notice	Supersedes			
BC846BS_1	20090824	Product data sheet	-	-			

## **13. Legal information**

## 13.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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[2] The term 'short data sheet' is explained in section "Definitions".

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